







# Axcen Photonics Corp. 創威光電股份有限公司

# 2024 Q3 Investor Conference

**TPEx Code** : **6530** 

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- This presentation includes forward-looking statements. All statements, other than statements of historical facts, that address activities, events or developments that Axcen Photonics Corp. expects or anticipates will or may occur in the future (including but not limited to projections, targets, estimates and business plans) are forward-looking statements.
- Axcen's actual results or developments may differ materially from those indicated by these forward-looking statements as a result of various factors and uncertainties, including but not limited to material cost increase, market demand, change in legal, financial and regulatory frameworks, government policies, financial market conditions, and other risks and factors beyond our control.
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### Agenda

- I. Company Introduction
- II. Industry Overview
- III. Our Products
- IV. Competition Advantage
- V. Business Performance
- VI. Prospect



# I. Company Introduction

- Founded Date: April 15<sup>th</sup>, 2002
- Paid-in Capital: NT\$ 337,500,000
- Number of Employees: 75 (as of September 30<sup>th</sup>, 2024)
- Chairman & CEO: Vincent Chen
- Main Products: Optical Transceivers & Sub-Assemblings
- Location: 6F No. 119 Baozhong Road, Xindian District New Taipei City
- Listing Date: January 23<sup>rd</sup>, 2018

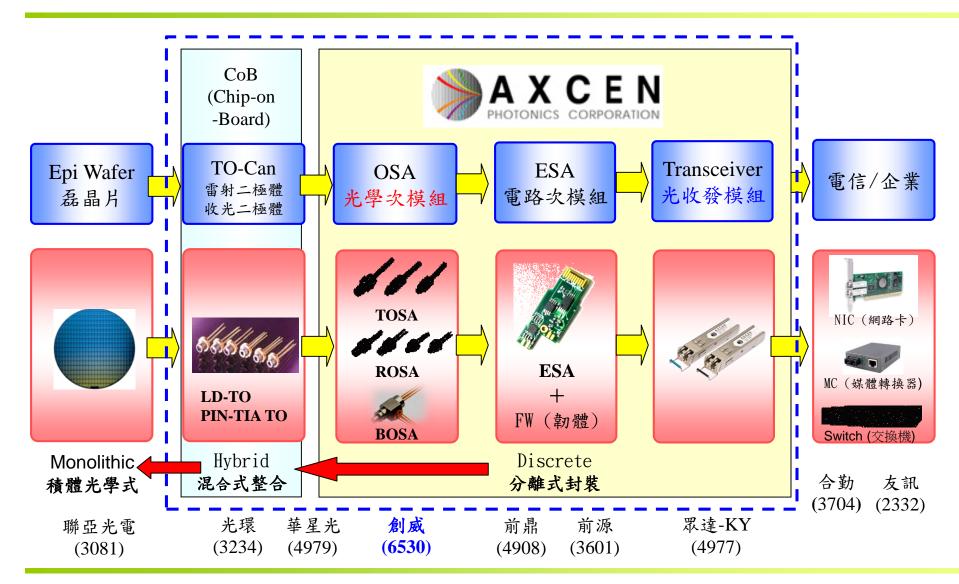




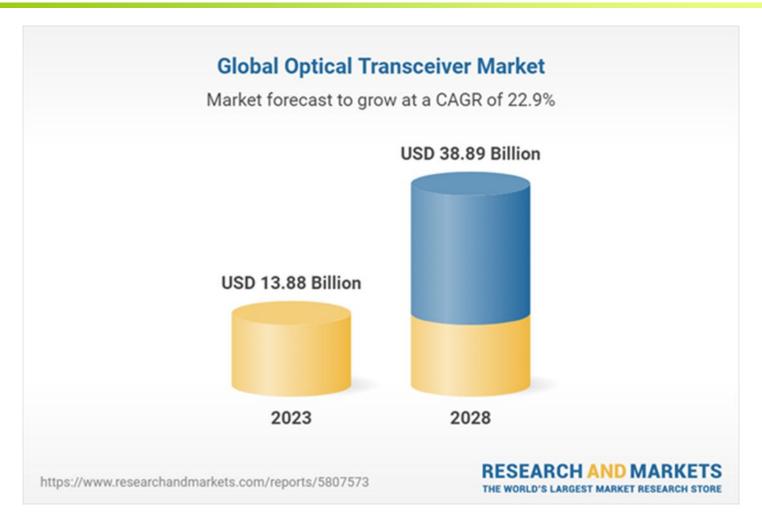




# **II. Industry Overview-Supply Chain**



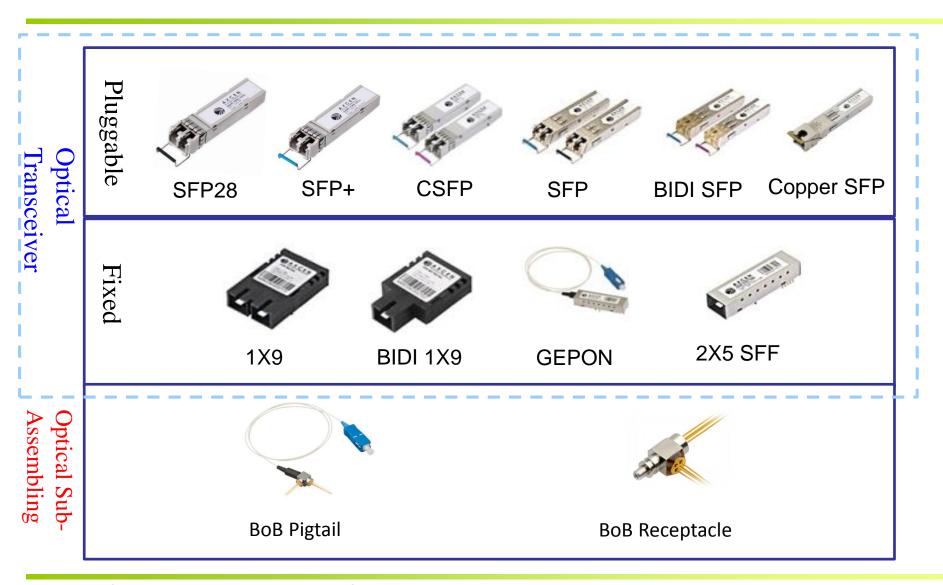
#### II. Industry Overview-Global Optical Transceiver Market



Source: Research and Markets (Market forecast to grow at a CAGR of 22.9% from 2023 to 2028)



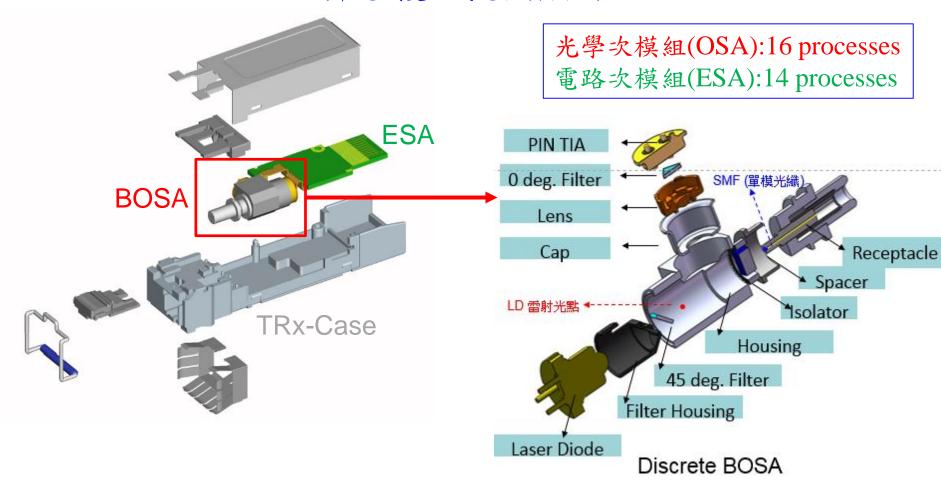
#### III. Our Products-Main Classification



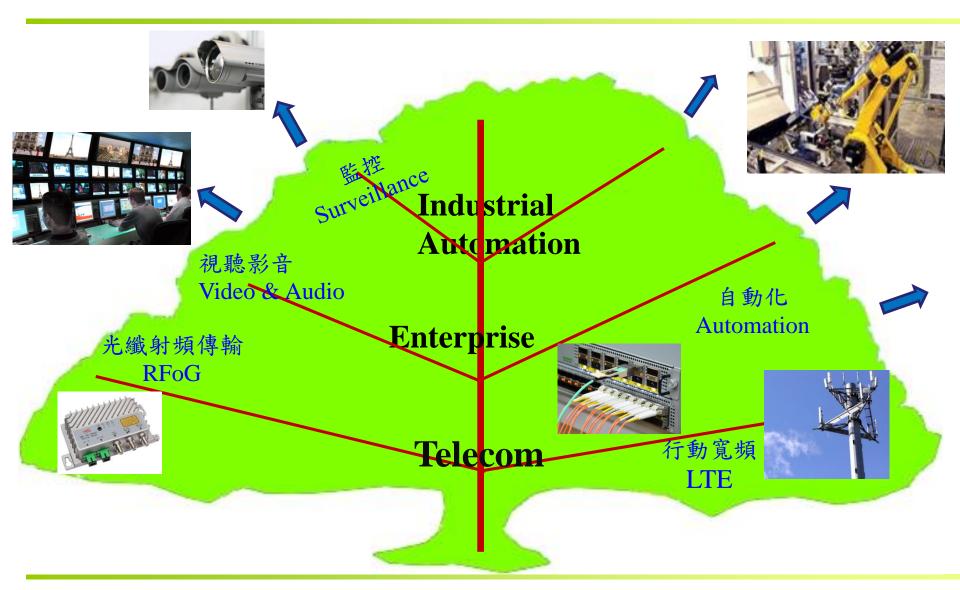
#### III. Our Products-Structure

**BIDI-SFP** 

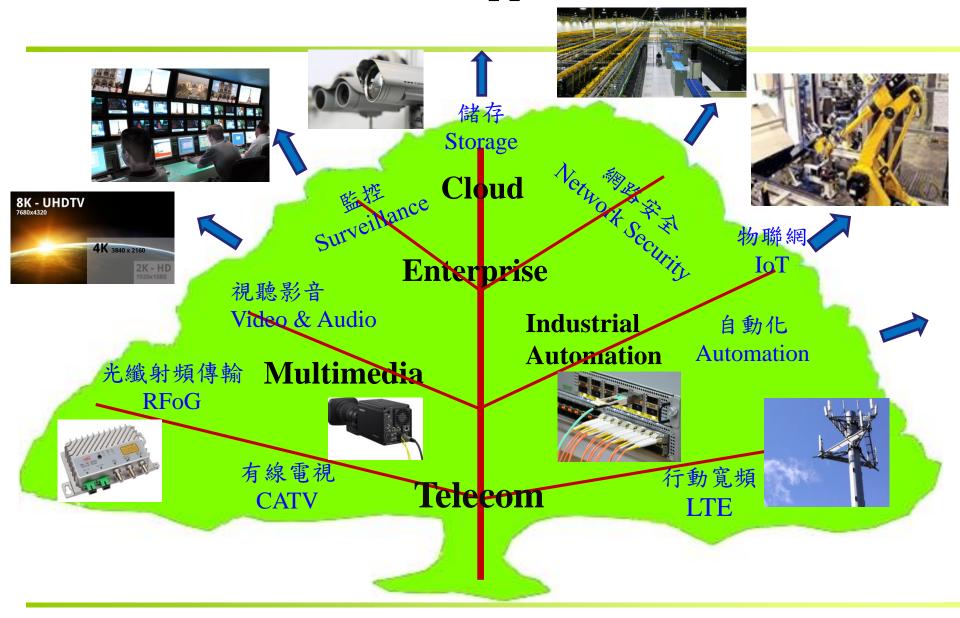
(單光纖雙向式光收發模組)



#### **III. Our Products-Application (Now)**



#### **III. Our Products-Application (Future)**





# IV. Competition Advantage- Niche Points in All Applications

<b>Application Fields</b>	Niche Points	Featured Products
Telecom	<ol> <li>Products contain high quality and long-term reliability / stability , deeply trusted by major telecom carriers.</li> <li>In-house capability of F/W development , which enhances product values &amp; compatibility for the customers.</li> </ol>	SFP-DD BoB
Enterprise	<ol> <li>Products own the benefit of miniaturization , which fully saves the space and cost for the enterprise customers.</li> <li>Products own the benefit of intellectualization , which is deeply appreciated by enterprise customers.</li> </ol>	CSFP Copper- -SFP
Industrial Automation	<ol> <li>Products possess long-term reliability / stability under severe high / low temperature</li> <li>Can be applied to ultra surge, humidity, corrosionetc., such kind of extremely harsh environment.</li> <li>Can offer highly value-added customization services to the customers in the field of industrial automation.</li> </ol>	1x9-IT SFP-IT SFP-CC
Video & Audio Broadcasting Multimedia	<ol> <li>Complete patents arrangement (under application) , which contains the competitive advantage among peers.</li> <li>In the leading position to contact potentially key customers , and conduct joint development for the high-end products 12G and 25G, so that future growth could be expected.</li> </ol>	SFP-SDI SFP-IP

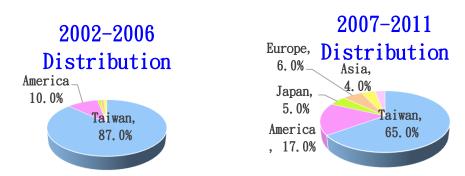
# IV. Major Competition Advantage

#### Axcen's competitive advantages in optical communication market

- Has core optical design and development capabilities
- Master key manufacturing processes (including fast photo-coupling and submicron laser packaging)
- Has high-frequency circuit design and firmware development capabilities, can cooperate with customers to provide high-value **customized** products and services
- Products have **high quality** and **long-term stability**
- Revenue generated from diverse customers, multi-applications and different regions, which results to lower operation risk and more energy to grow
- Professional team with 20+ years of experience
- The products have been recognized by many world-class manufacturers and have stable and healthy orders
- Healthy and stable financial position



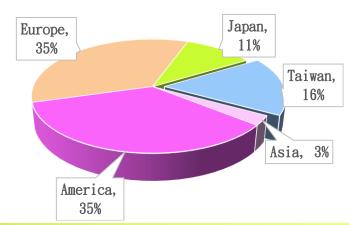
#### V. Business Performance-Sales Area Distribution



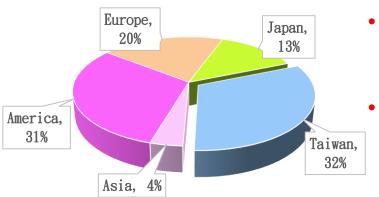
 Single Market Concentration



#### 2022-2023 Distribution

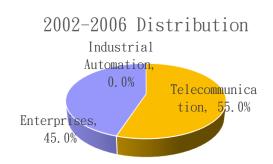


#### 2017-2021 Distribution

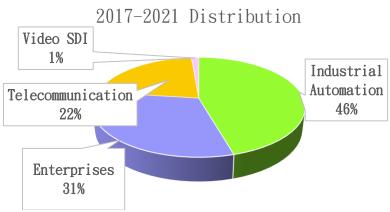


- Continuous
  Growth in All
  Regions
- Widespread Market Reach

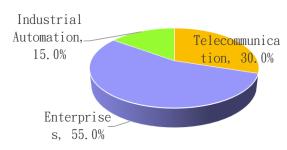
#### V. Business Performance-Sales Application Distribution



Reliant on the telecommunications industry

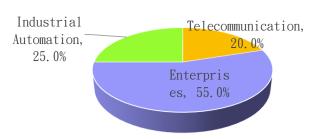


#### 2007-2011 Distribution



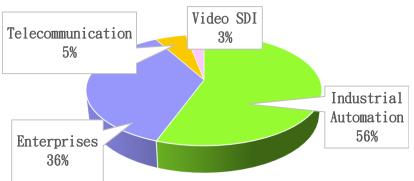
Industrial Automation sector begins to grow, while telecommunications' share decreases

#### 2012-2016 Distribution



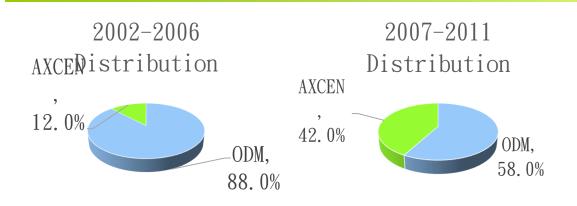
The industrial Automation sector's share becomes more stable and continues to increase

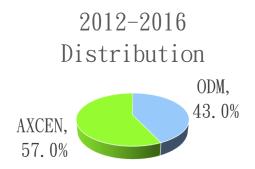
#### 2022-2023 Distribution





#### V. Business Performance-Sales Brand Distribution



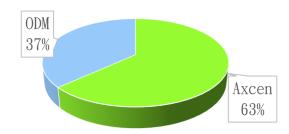


Dominated by ODM during early stage

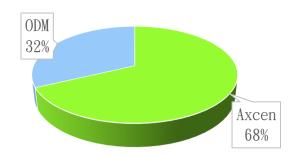
Axcen's own brand sales gradually increase

The share of Axcen's own brand surpasses ODM





#### 2022-2023 Distribution



#### V. Business Performance-Recent Financial Result

				In NT\$ thousands	
Item	2021	2022 YOY%	2023 YOY%	2024Q2 YOY%	
Operating Revenue	271,302	274,207 1.07%	251,831 -8.16%	133,863 9.23%	
Gross Margin	38.89%	44.67%	42.86%	43.21%	
Operating Income	46,158	60,738 31.59%	48,328 -20.43%	25,468 15.28%	
Income before Tax	36,710	53,776 46.49%	42,218 -21.49%	24,821 24.94%	
Basic EPS (NT\$)	1.09	1.59	1.25	0.74	

### VI. Prospect-Manufacturing Technology

Discrete



Hybrid



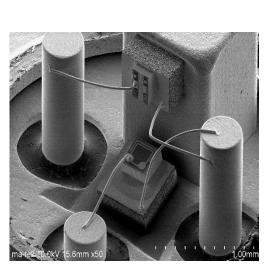
Monolithic

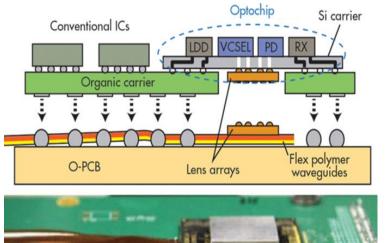
分離式元件封裝

混合式元件整合

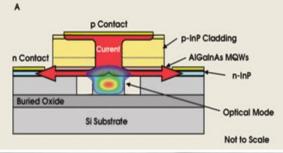
積體光學式

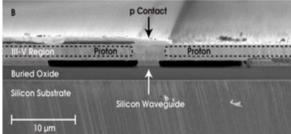
CoB (Chip-on-Board) or CoS (Chip-on-Substrate) (買 LD, PD, IC, Optics 等 Chip元件, 封裝整合到基板上)











Chip-on-Header

Chip-on-PCB

16

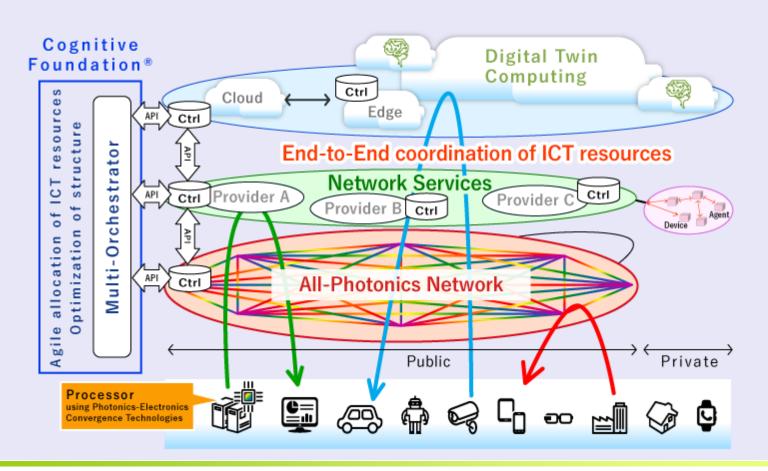
Chip-on-Silicon (Si-Photonics)



# VI. Prospect-Application Development

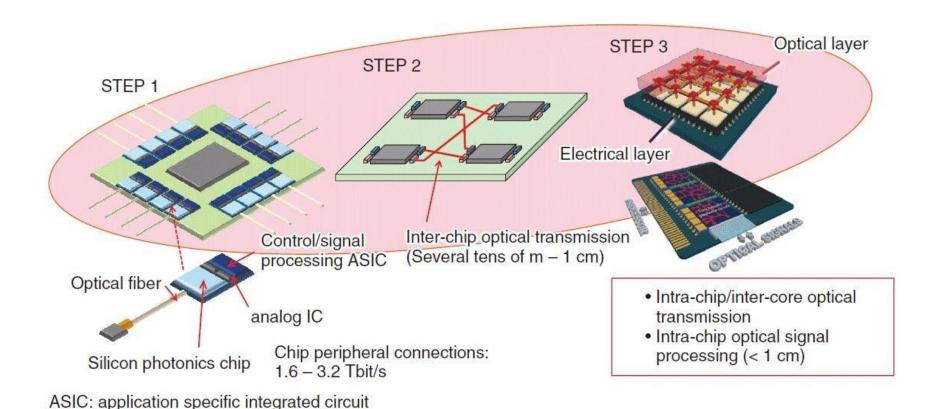
#### Innovative Optical and Wireless Network (IOWN)

Realizing a Smart World by using the 3 elements of All Photonics Network, Digital Twin Computing and Cognitive Foundation





# VI. Prospect-Product Development



# VI. Prospect-Product Application

# Main applications of silicon photonics

- Communication
- Cloud computing
- AR/VR
- Optical sensing
- Biomedicine
- Quantum computing
- Quantum communication
- LiDAR (Laser Detection and Ranging)

2022~2027 Estimated market size of silicon photonic modules

(Source: ITRI)

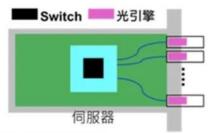


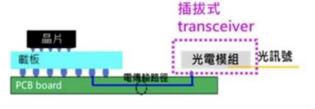


# VI. Prospect-Manufacturing Technology

#### (a) 插拔式光收發模組 (Transceiver)架構

光引擎設置在伺服器板外(插拔式 transceiver上)





#### Axcen vs. SiPH

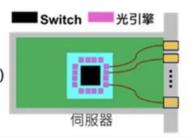
- ✓ Optical Coupling Design
- ✓ Optical Mux/DeMux Design

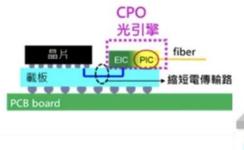
Si-Photonics integration chip

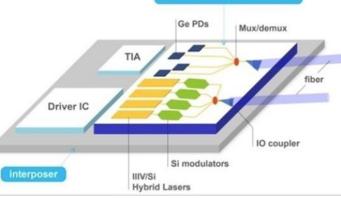
✓ CPO共同封裝

#### (b) 共封裝光學模組(CPO)架構

光引擎設置在伺服 器板內(CPO模組上)









# VI. Prospect-Product Roadmap

	CAT	MMF	2km SMF	10km SMF	40km SMF	
1000BASE	-T	-SX	-SX2	-LX	-LHX	
1000D ACE	T	CV	CNO	T 37	LIIV	
10GBASE	-T	-SR	-LR-Lite	-LR	-ER	
25GBASE	-T	-SR		-LR	-ER	
50GBASE		SR4(25Gx4) -SR(PAM4)	-FR(PAM4)	-LxR(PAM4)	-ER(PAM4)	
100GBASE		- SD4(25C <sub>34</sub> 4)	-CWDM4(25Gx4)	-LR4(25Gx4)	-ER4(25Gx4)	
200GBASE		-SR4(50Gx4)	-FR4(50Gx4)	-LR4(50Gx4)	-ER4(50Gx4)	
400GBASE		-SR8(50Gx8)	-FR8(50Gx8)	-LR8(50Gx8)	-ER8(50Gx8)	

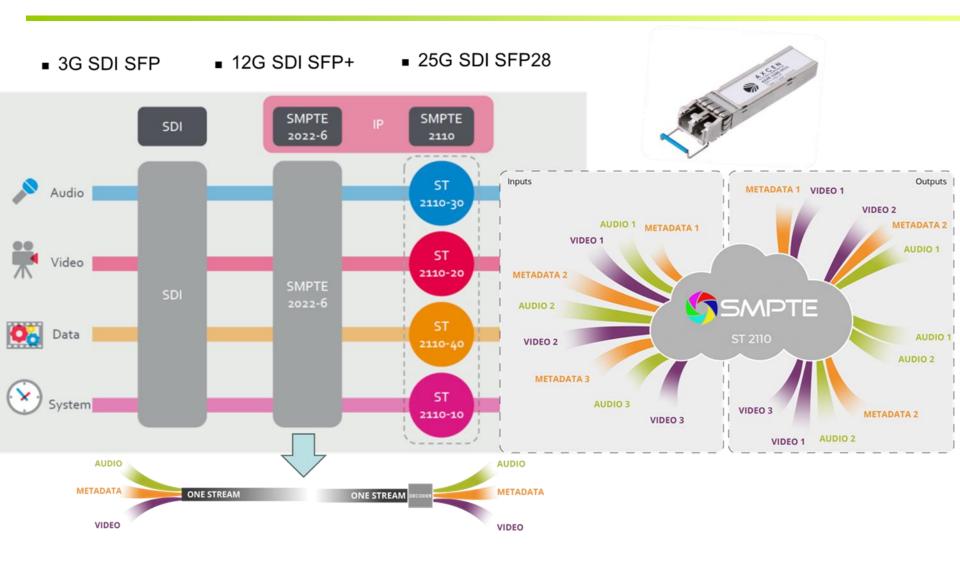
#### **Product Roadmap:**

#### **Higher Data-rate, More Compact**



#### **Product Roadmap:**

#### Video & Audio













# Q & A

